Transistors Panasonic

## 2SD1820

## Silicon NPN epitaxial planar type

For general amplification Complementary to 2SB1219

#### ■ Features

- $\bullet$  Low collector-emitter saturation voltage  $V_{\text{CE(sat)}}$
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	30	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	25	V	
Emitter-base voltage (Collector open)	$V_{\rm EBO}$	5	V	
Collector current	$I_{C}$	500	mA	
Peak collector current	I <sub>CP</sub>	1	A	
Collector power dissipation	$P_{\rm C}$	150	mW	
Junction temperature	T <sub>j</sub>	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

#### ■ Package

- Code
  - SMini3-G1
- Pin Name
  - 1. Base
  - 2. Emitter
  - 3. Collector
- Marking Symbol: W

### ■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu {\rm A}, I_{\rm E} = 0$	30	Up.		V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 2 \text{ mA}, I_{\rm B} = 0$	25	)		V	
Emitter-base voltage (Collector open)	$V_{\mathrm{EBO}}$	$I_E = 10 \mu A, I_C = 0$	5			V	
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 20 \text{ V}, I_{E} = 0$			0.1	μΑ	
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	85		340		
	h <sub>FE2</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 500 \text{ mA}$	40			_	
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_C = 300 \text{ mA}, I_B = 30 \text{ mA}$		0.35	0.60	V	
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_{E} = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz	
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		6	15	pF	

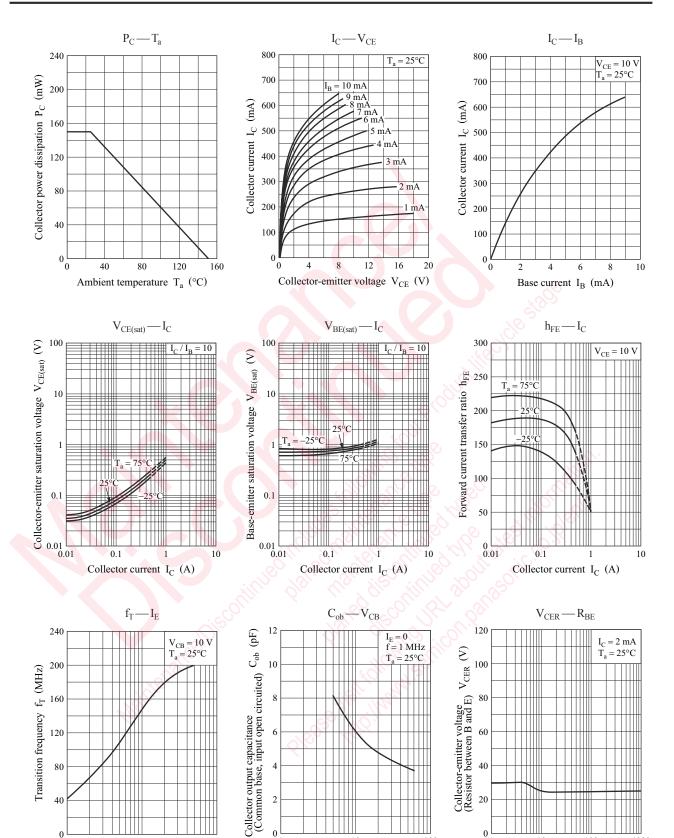
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

- 2. \*1: Pulse measurement
  - \*2: Rank classification

Rank	Q	R	S	No-rank
$h_{\mathrm{FE1}}$	85 to 170	120 to 240	170 to 340	85 to 340
Marking symbol	WQ	WR	WS	_

Product of no-rank is not classified and have no marking symbol for rank.

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Collector-base voltage V<sub>CB</sub> (V)

100

1000

100

Base-emitter resistance  $R_{BE}$  (k $\Omega$ )

2 SJC00227DED

-100

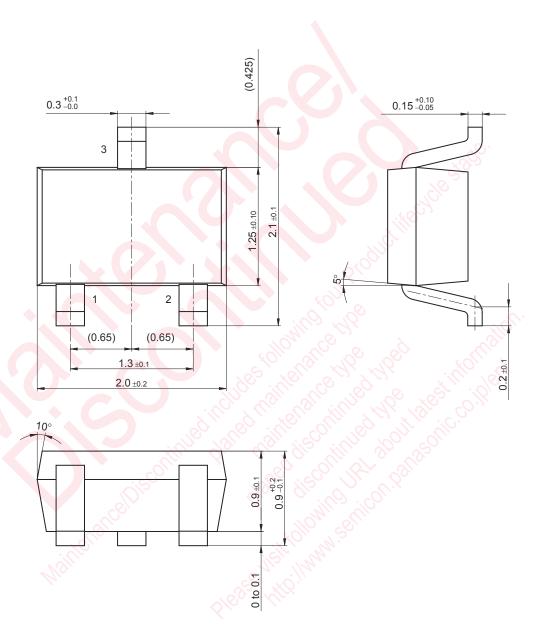
-10

Emitter current I<sub>E</sub> (mA)

40

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SMini3-G1 Unit: mm



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